

SN54ABT863, SN74ABT863 9-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS201E – FEBRUARY 1991 – REVISED JULY 1998

- State-of-the-Art *EPIC-IIB*™ BiCMOS Design Significantly Reduces Power Dissipation
- Typical V_{OLP} (Output Ground Bounce) < 1 V at $V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$
- High-Impedance State During Power Up and Power Down
- High-Drive Outputs (–32-mA I_{OH} , 64-mA I_{OL})
- Latch-Up Performance Exceeds 500 mA Per JESD 17
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Package Options Include Plastic Small-Outline (DW), Shrink Small-Outline (DB) Packages, and Thin Shrink Small-Outline (PW), Ceramic Chip Carriers (FK), Plastic (NT), and Ceramic (JT) DIPs

description

The 'ABT863 devices are 9-bit transceivers designed for asynchronous communication between data buses. The control-function implementation allows for maximum flexibility in timing.

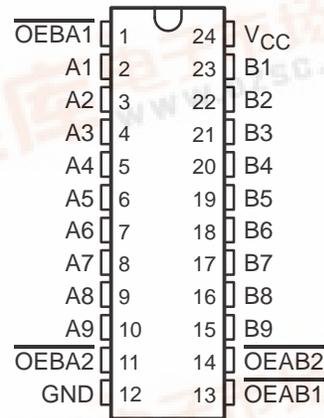
These devices allow noninverted data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic levels at the output-enable ($\overline{\text{OEAB}}$ and $\overline{\text{OEBA}}$) inputs.

The outputs are in the high-impedance state during power up and power down. The outputs remain in the high-impedance state while the device is powered down.

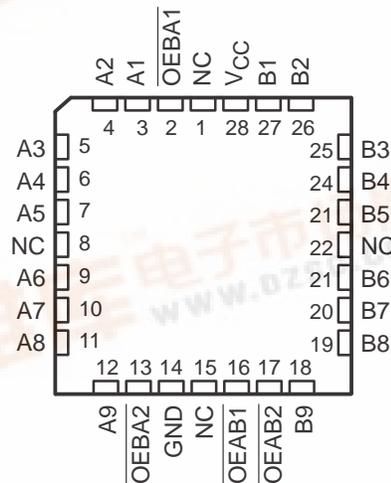
When V_{CC} is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 2.1 V, $\overline{\text{OE}}$ should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABT863 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74ABT863 is characterized for operation from -40°C to 85°C .

SN54ABT863 ... JT PACKAGE
SN74ABT863 ... DB, DW, NT, OR PW PACKAGE
(TOP VIEW)



SN54ABT863 ... FK PACKAGE
(TOP VIEW)



NC – No internal connection

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

EPIC-IIB is a trademark of Texas Instruments Incorporated.

UNLESS OTHERWISE NOTED this document contains PRODUCTION DATA information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

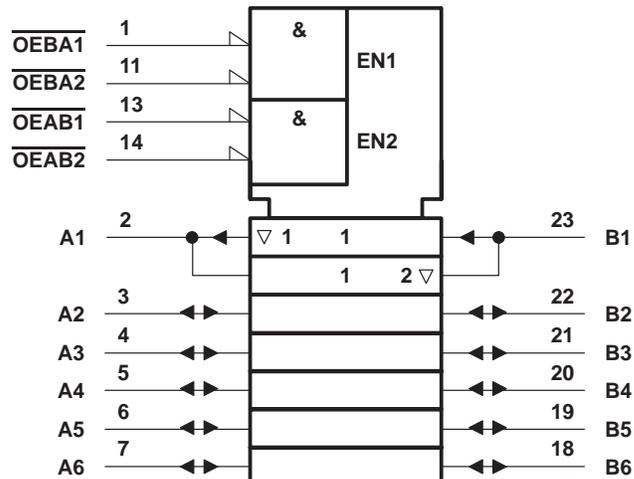
SN54ABT863, SN74ABT863 9-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS201E – FEBRUARY 1991 – REVISED JULY 1998

FUNCTION TABLE

| INPUTS | | | | OPERATION |
|--------|-------|-------|-------|---------------|
| OEAB1 | OEAB2 | OEBA1 | OEBA2 | |
| L | L | L | L | Latch A and B |
| L | L | H | X | A to B |
| L | L | X | H | A to B |
| H | X | L | L | B to A |
| X | H | L | L | B to A |
| H | X | H | X | Isolation |
| H | X | X | H | |
| X | H | X | H | |
| X | H | H | X | |

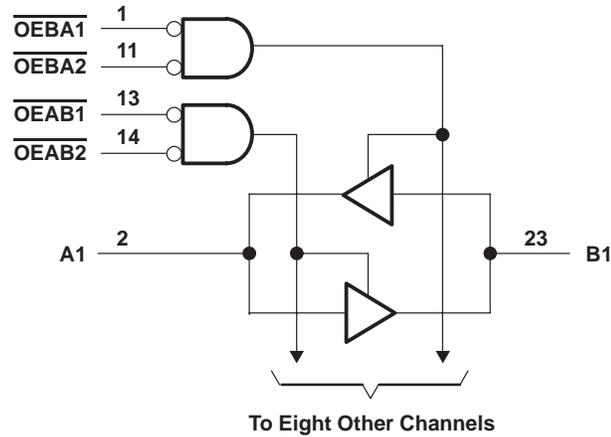
logic symbol†



SN54ABT863, SN74ABT863 9-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS201E – FEBRUARY 1991 – REVISED JULY 1998

logic diagram (positive logic)



Pin numbers shown are for the DB, DW, JT, NT, and PW packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| | |
|---|-----------------|
| Supply voltage range, V_{CC} | -0.5 V to 7 V |
| Input voltage range, V_I (except I/O ports) (see Note 1) | -0.5 V to 7 V |
| Voltage range applied to any output in the high or power-off state, V_O | -0.5 V to 5.5 V |
| Current into any output in the low state, I_O : SN54ABT863 | 96 mA |
| SN74ABT863 | 128 mA |
| Input clamp current, I_{IK} ($V_I < 0$) | -18 mA |
| Output clamp current, I_{OK} ($V_O < 0$) | -50 mA |
| Package thermal impedance, θ_{JA} (see Note 2): DB package | 104°C/W |
| DW package | 81°C/W |
| NT package | 67°C/W |
| PW package | 120°C/W |
| Storage temperature range, T_{Stg} | -65°C to 150°C |

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.

SN54ABT863, SN74ABT863
9-BIT BUS TRANSCEIVERS
WITH 3-STATE OUTPUTS

SCBS201E – FEBRUARY 1991 – REVISED JULY 1998

recommended operating conditions (see Note 3)

| | | SN54ABT863 | | SN74ABT863 | | UNIT |
|---------------------|------------------------------------|-----------------|-----------------|------------|-----------------|------|
| | | MIN | MAX | MIN | MAX | |
| V _{CC} | Supply voltage | 4.5 | 5.5 | 4.5 | 5.5 | V |
| V _{IH} | High-level input voltage | 2 | | 2 | | V |
| V _{IL} | Low-level input voltage | | 0.8 | | 0.8 | V |
| V _I | Input voltage | 0 | V _{CC} | 0 | V _{CC} | V |
| I _{OH} | High-level output current | | -24 | | -32 | mA |
| I _{OL} | Low-level output current | | 48 | | 64 | mA |
| Δt/Δv | Input transition rise or fall rate | Outputs enabled | | | 5 | ns/V |
| Δt/ΔV _{CC} | Power-up ramp rate | 200 | | 200 | | μs/V |
| T _A | Operating free-air temperature | -55 | 125 | -40 | 85 | °C |

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

SN54ABT863, SN74ABT863 9-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS201E – FEBRUARY 1991 – REVISED JULY 1998

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | T _A = 25°C | | | SN54ABT863 | | SN74ABT863 | | UNIT |
|--------------------|--|--|------------------|-------|------------|-------|------------|------|------|
| | | MIN | TYP† | MAX | MIN | MAX | MIN | MAX | |
| V _{IK} | V _{CC} = 4.5 V, I _I = -18 mA | | | -1.2 | | -1.2 | | -1.2 | V |
| V _{OH} | V _{CC} = 4.5 V, I _{OH} = -3 mA | 2.5 | | | 2.5 | | 2.5 | | V |
| | V _{CC} = 5 V, I _{OH} = -3 mA | 3 | | | 3 | | 3 | | |
| | V _{CC} = 4.5 V, I _{OH} = -24 mA | 2 | | | 2 | | | | |
| V _{OL} | V _{CC} = 4.5 V, I _{OL} = 48 mA | | | 0.55 | | 0.55 | | | V |
| | | | | 0.55* | | | 0.55 | | |
| V _{hys} | | | 100 | | | | | | mV |
| I _I | Control inputs | V _{CC} = 0 to 5.5 V, V _I = V _{CC} or GND | | ±1 | | ±1 | | ±1 | μA |
| | A or B ports | V _{CC} = 2.1 V to 5.5 V, V _I = V _{CC} or GND | | ±20 | | ±20 | | ±20 | |
| I _{OZPU} | V _{CC} = 0 to 2.1 V, V _O = 0.5 V to 2.7 V, OE = * don't care | | | ±50 | | ±50** | | ±50 | μA |
| I _{OZPD} | V _{CC} = 2.1 V to 0, V _O = 0.5 V to 2.7 V, OE = * don't care | | | ±50 | | ±50** | | ±50 | μA |
| I _{OZH} ‡ | V _{CC} = 2.1 V to 5.5 V, V _O = 2.7 V, OE ≥ 2 V | | | 10 | | 10 | | 10 | μA |
| I _{OZL} ‡ | V _{CC} = 2.1 V to 5.5 V, V _O = 0.5 V, OE ≥ 2 V | | | -10 | | -10 | | -10 | μA |
| I _{off} | V _{CC} = 0, V _I or V _O ≤ 4.5 V | | | ±100* | | | | ±100 | μA |
| I _{CEX} | V _{CC} = 5.5 V, V _O = 5.5 V | | | 50 | | 50 | | 50 | μA |
| I _O § | V _{CC} = 5.5 V, V _O = 2.5 V | -50 | -100 | -225 | -50 | -225 | -50 | -225 | mA |
| I _{CC} | A or B ports | V _{CC} = 5.5 V, I _O = 0, V _I = V _{CC} or GND | Outputs high | 1 | 250 | 250 | 250 | 250 | μA |
| | | | Outputs low | 24 | 30 | 38 | 38 | 38 | mA |
| | | | Outputs disabled | 0.5 | 250 | 250 | 250 | 250 | μA |
| ΔI _{CC} ¶ | Data inputs | V _{CC} = 5.5 V, One input at 3.4 V, Other inputs at V _{CC} or GND | Outputs enabled | | 1.5 | 1.5 | 1.5 | mA | |
| | | | Outputs disabled | | 0.05 | 0.05 | 0.05 | | |
| | Control inputs | V _{CC} = 5.5 V, One input at 3.4 V, Other inputs at V _{CC} or GND | | 1.5 | 1.5 | 1.5 | | | |
| C _i | Control inputs | V _I = 2.5 V or 0.5 V | | 4 | | | | pF | |
| C _{io} | A or B ports | V _O = 2.5 V or 0.5 V | | 7 | | | | pF | |

* On products compliant to MIL-PRF-38535, this parameter does not apply.

** On products compliant to MIL-PRF-38535, this parameter is not production tested.

† All typical values are at V_{CC} = 5 V.

‡ The parameters I_{OZH} and I_{OZL} include the input leakage current.

§ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

¶ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

SN54ABT863, SN74ABT863
9-BIT BUS TRANSCEIVERS
WITH 3-STATE OUTPUTS

SCBS201E – FEBRUARY 1991 – REVISED JULY 1998

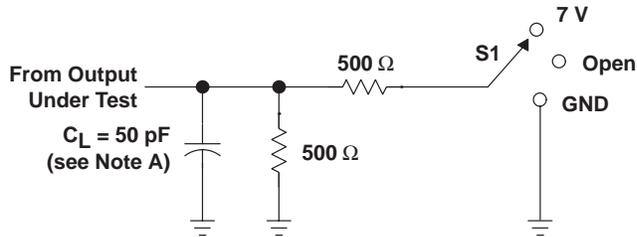
switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $V_{CC} = 5 \text{ V},$ $T_A = 25^\circ\text{C}$ | | | SN54ABT863 | | SN74ABT863 | | UNIT |
|-----------|--|-------------|---|-----|-----|------------|-----|------------|-----|------|
| | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| t_{PLH} | A or B | B or A | 1 | 2.6 | 4.1 | 1 | 7 | 1 | 5.7 | ns |
| t_{PHL} | | | 1 | 2.3 | 3.3 | 1 | 3.9 | 1 | 3.9 | |
| t_{PZH} | \overline{OEAB} or \overline{OEBA} | B or A | 1 | 3.2 | 4.3 | 1 | 5.4 | 1 | 5.5 | ns |
| t_{PZL} | | | 1 | 3.3 | 4.4 | 5.5 | 1 | 5.4 | | |
| t_{PHZ} | \overline{OEAB} or \overline{OEBA} | B or A | 2.5 | 4.8 | 6 | 2.5 | 6.8 | 2.5 | 6.7 | ns |
| t_{PLZ} | | | 1.5 | 4.4 | 5.9 | 1.5 | 7.8 | 1.5 | 6.9 | |

SN54ABT863, SN74ABT863
 9-BIT BUS TRANSCEIVERS
 WITH 3-STATE OUTPUTS

SCBS201E – FEBRUARY 1991 – REVISED JULY 1998

PARAMETER MEASUREMENT INFORMATION



| TEST | S1 |
|-------------------|------|
| t_{PLH}/t_{PHL} | Open |
| t_{PLZ}/t_{PZL} | 7 V |
| t_{PHZ}/t_{PZH} | Open |

LOAD CIRCUIT

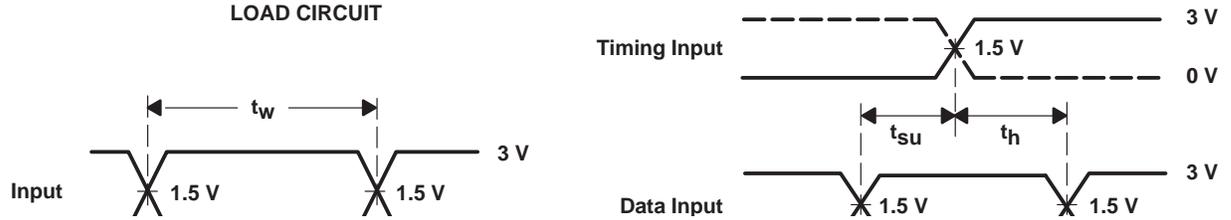


Figure 1. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| SN74ABT863DBLE | OBSOLETE | SSOP | DB | 24 | | TBD | Call TI | Call TI |
| SN74ABT863DBR | ACTIVE | SSOP | DB | 24 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT863DBRE4 | ACTIVE | SSOP | DB | 24 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT863DW | ACTIVE | SOIC | DW | 24 | 25 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT863DWE4 | ACTIVE | SOIC | DW | 24 | 25 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT863DWR | ACTIVE | SOIC | DW | 24 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT863DWRE4 | ACTIVE | SOIC | DW | 24 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT863NT | ACTIVE | PDIP | NT | 24 | 15 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| SN74ABT863NTE4 | ACTIVE | PDIP | NT | 24 | 15 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer:The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

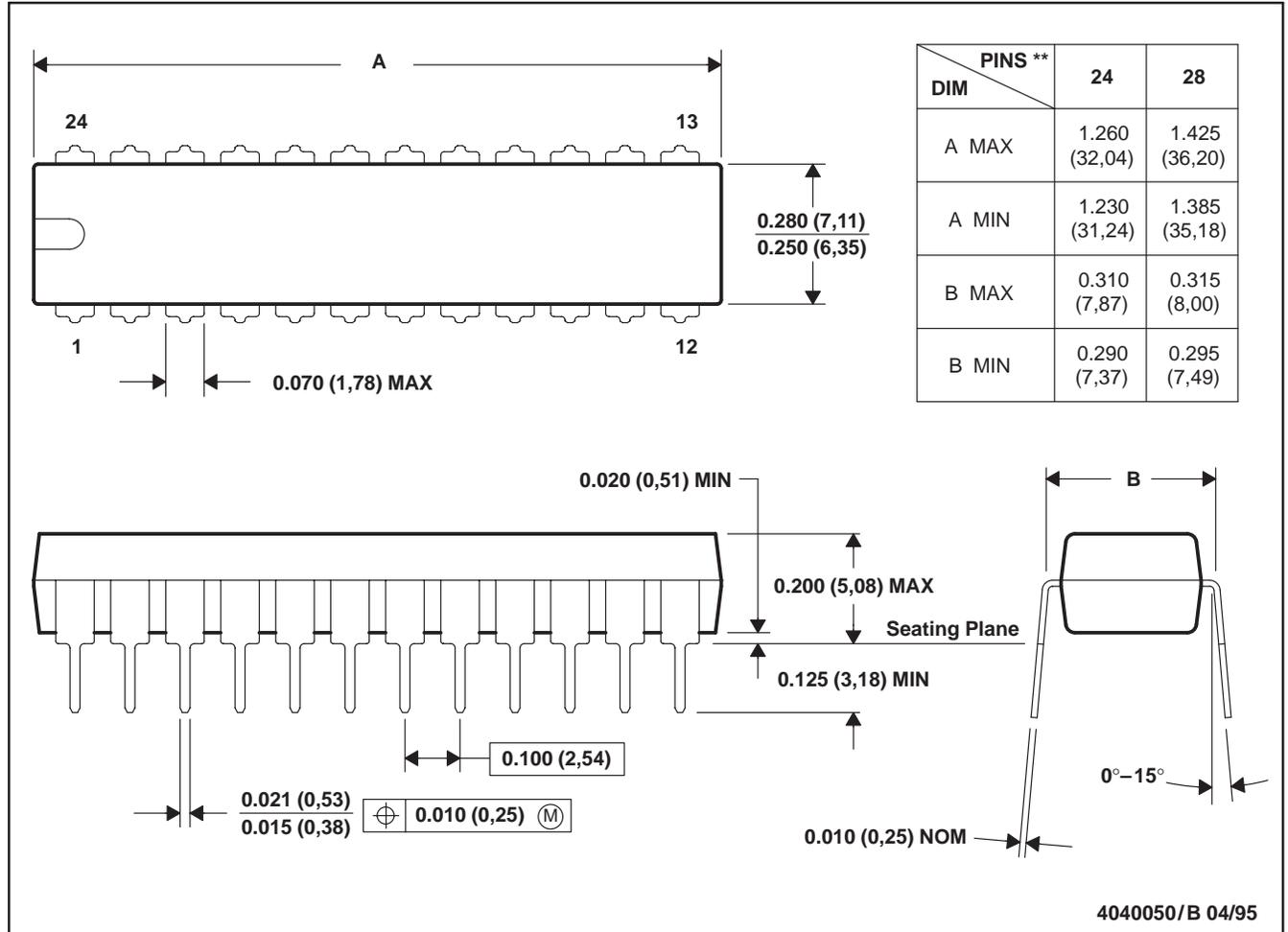
MECHANICAL DATA

MPDI004 – OCTOBER 1994

NT (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

24 PINS SHOWN

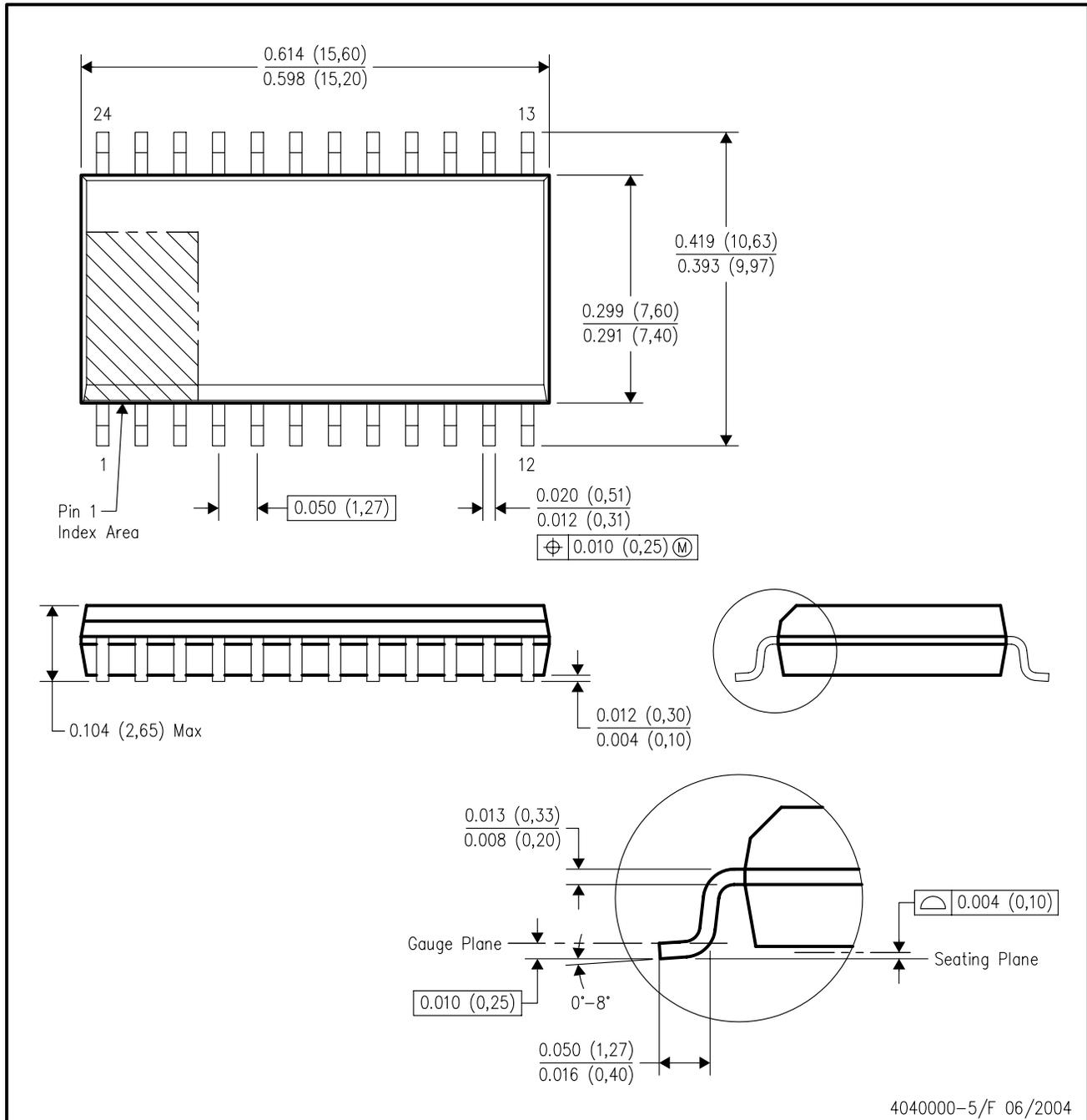


- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.

MECHANICAL DATA

DW (R-PDSO-G24)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 - Falls within JEDEC MS-013 variation AD.

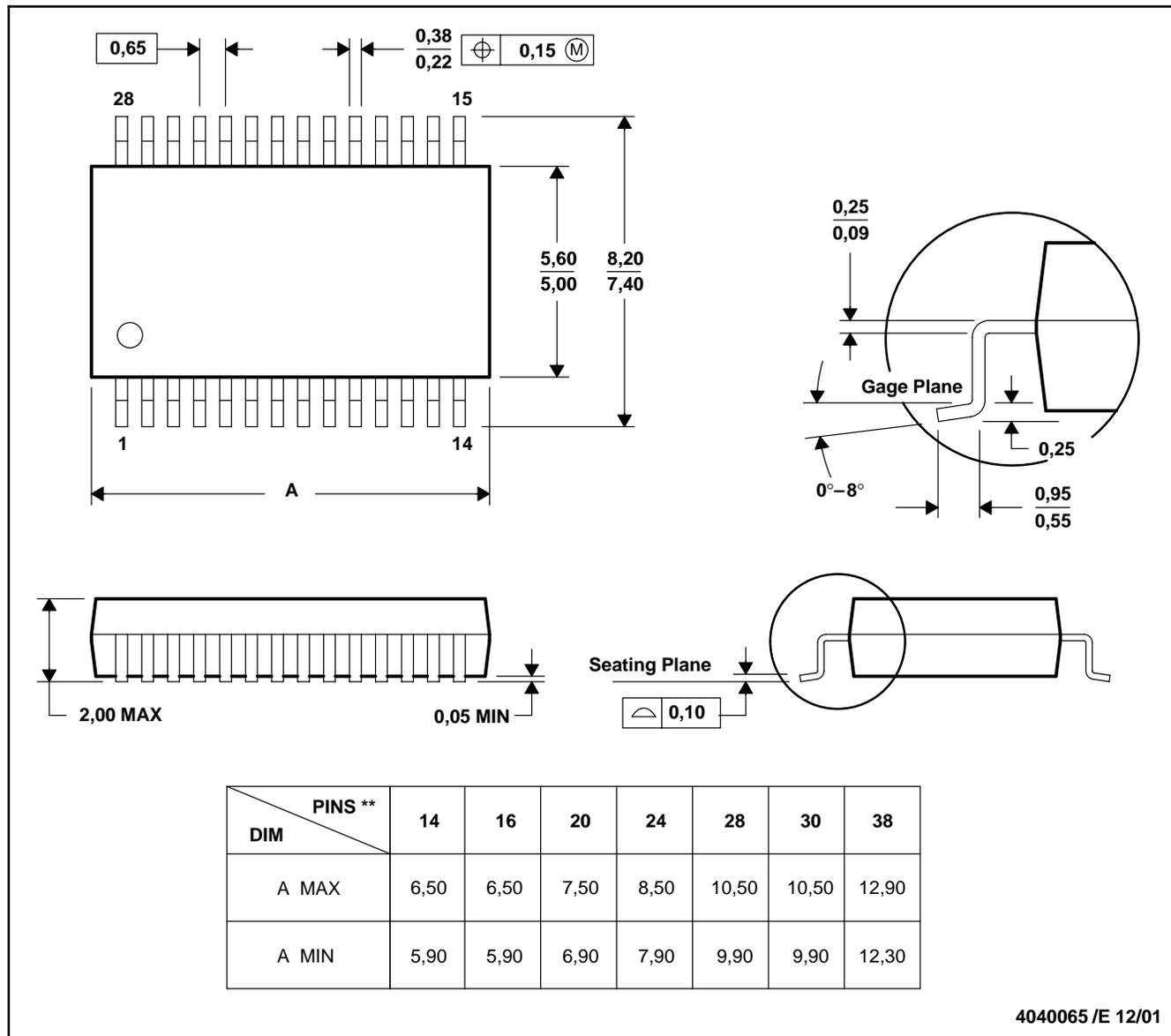
MECHANICAL DATA

MSS0002E – JANUARY 1995 – REVISED DECEMBER 2001

DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-150

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

| Products | | Applications | |
|------------------|--|---------------------|--|
| Amplifiers | amplifier.ti.com | Audio | www.ti.com/audio |
| Data Converters | dataconverter.ti.com | Automotive | www.ti.com/automotive |
| DSP | dsp.ti.com | Broadband | www.ti.com/broadband |
| Interface | interface.ti.com | Digital Control | www.ti.com/digitalcontrol |
| Logic | logic.ti.com | Military | www.ti.com/military |
| Power Mgmt | power.ti.com | Optical Networking | www.ti.com/opticalnetwork |
| Microcontrollers | microcontroller.ti.com | Security | www.ti.com/security |
| | | Telephony | www.ti.com/telephony |
| | | Video & Imaging | www.ti.com/video |
| | | Wireless | www.ti.com/wireless |

Mailing Address: Texas Instruments
Post Office Box 655303 Dallas, Texas 75265